IPC ASSOCIATION CONNECT ELECTRONICS INDUSTI	© Copyright 2005. IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information				
upplier Infor	mation													
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
onsemi											2025-06-08			
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Env-Ste	wards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com			
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Product-Env-Stewards			Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com			
Reque	ster Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	N	Manufacturing Site	We	ight*	UOM	Unit Type
	FSV2050V 2		20 A 50V Schottky			2025-06-08		P	PANJITFG		0	mg	Each	
	g Proccess Informational Plating / Grid Array Mate		arminal Raca	Alloy	STD-020 MSL	Pating	Dank Proc	es Rody T	amparatur	e Max Time at Peak	Tamparatura	Numb	er of Reflow Cyc	lac
		Terminal Base Alloy J-STD-CU Alloy 1		31D-020 MSL	Kanng	Peak Process Body Tempera 260 C		Τ'				el of Kellow Cyc	ies	
•	im (Sii) - amlealeu	C	U Anoy	1			400		IC	30	seconds	<u> </u>		
omments	ı time at peak temperatur	o during sale	doring is 10.3	0 seconds										
t more informa	ition regarding material co	omposition p	piease refer to	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Priective 2015/863/EU amending RoHS directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	4.942	mg	Supplier	Zinc (Zn)	7440-66-6		0.0059	mg
			Supplier	Iron (Fe)	7439-89-6		0.1161	mg
			Supplier	Copper (Cu)	7440-50-8		4.8184	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0015	mg
Die	9.594	mg	Supplier	Silicon (Si)	7440-21-3		9.594	mg
Die Attach Solder	4.165	mg	Supplier	Silver (Ag)	7440-22-4		0.1041	mg
			A	Lead (Pb)	7439-92-1	7a	3.8526	mg
			Supplier	Tin (Sn)	7440-31-5		0.2083	mg
Lead Frame	30.081	mg	Supplier	Chromium (Cr)	7440-47-3		0.0602	mg
			Supplier	Manganese (Mn)	7439-96-5		0.2406	mg
			В	Nickel (Ni)	7440-02-0		12.3332	mg
			Supplier	Iron (Fe)	7439-89-6		17.447	mg
Mold Compound-Black	43.217	mg		Metal Hydroxide	proprietary data		1.5126	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.4574	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2161	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		34.5736	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		3.4574	mg
Plating	0.001	mg	Supplier	Tin (Sn)	7440-31-5		0.001	mg